

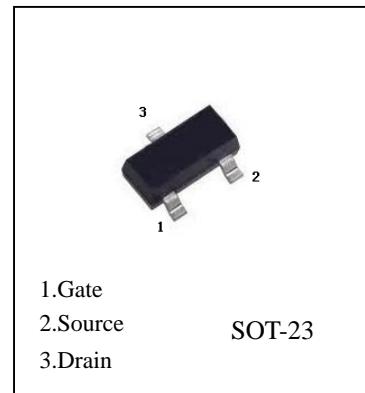
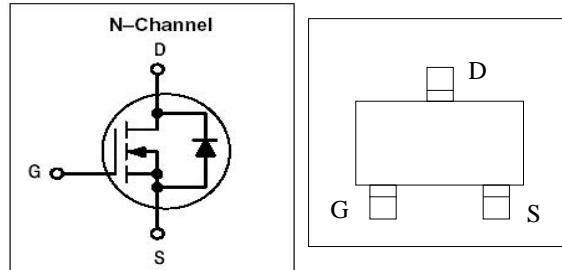
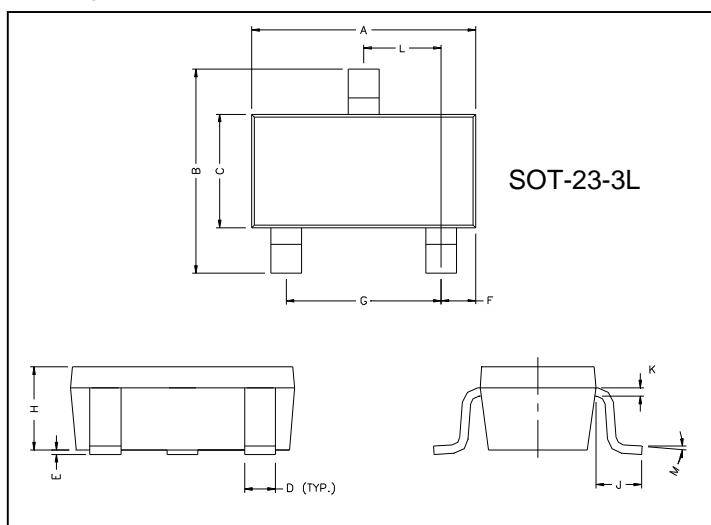
CURRENT 5.8 Ampere
VOLTAGE RANG 30 Volts

AO3400

VDS= 30V**RDS(ON), Vgs@10V, Ids@5.8A < 28mΩ****RDS(ON), Vgs@4.5V, Ids@5.0A < 33mΩ****RDS(ON), Vgs@2.5V, Ids@4.0A < 52mΩ****Features**

Advanced trench process technology

High Density Cell Design For Ultra Low On-Resistance

**Package Dimensions**

REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	2.70	3.10	G	1.90	REF.
B	2.65	2.95	H	1.00	1.30
C	1.50	1.70	K	0.10	0.20
D	0.35	0.50	J	0.40	-
E	0	0.10	L	0.85	1.15
F	0.45	0.55	M	0°	10°

Maximum Ratings and Thermal Characteristics (TA = 25°C unless otherwise noted)

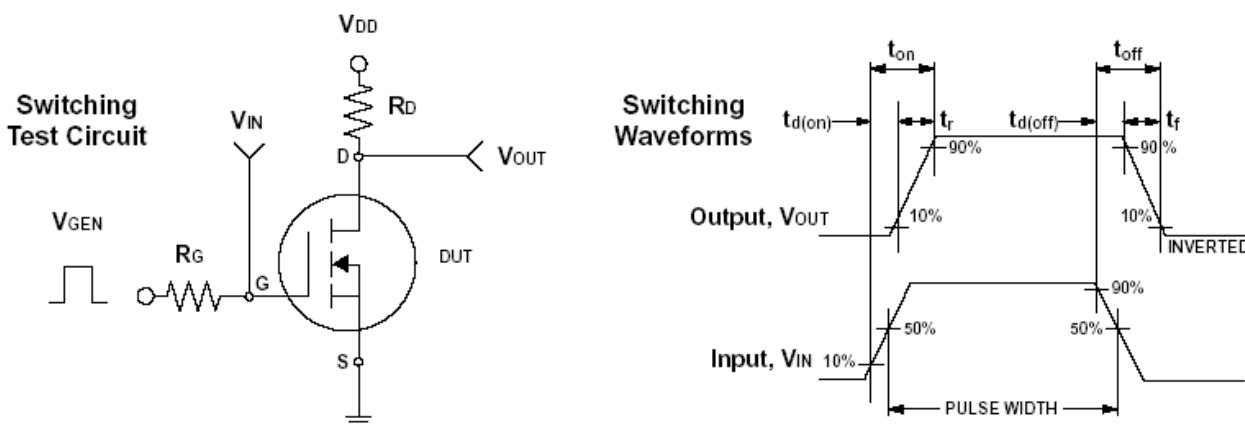
Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	± 12	
Continuous Drain Current	I _D	5.8	A
Pulsed Drain Current	I _{DM}	30	
Maximum Power Dissipation	TA = 25°C	P _D	W
	TA = 75°C		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C
Junction-to-Ambient Thermal Resistance (PCB mounted)	R _{θJA}	145	°C/W

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ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Miax.	Unit
Static						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 5.8A$		22.0	28.0	$m\Omega$
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 4.5V, I_D = 5A$		27.0	33.0	
Drain-Source On-State Resistance	$R_{DS(on)}$	$V_{GS} = 2.5V, I_D = 4A$		43.0	52.0	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.7		1.4	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 24V, V_{GS} = 0V$			1	μA
Gate Body Leakage	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			± 100	nA
Forward Transconductance	g_{fs}	$V_{DS} = 5V, I_D = 5A$	10	15	—	S
Gate Resistance	R_g	F=1.0MHz	6	7	7.5	Ω
Dynamic						
Total Gate Charge	Q_g	$V_{DS} = 15V, I_D = 5.8A$ $V_{GS} = 4.5V$		11	14	nC
Gate-Source Charge	Q_{gs}			1.6		
Gate-Drain Charge	Q_{gd}			2.8		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15V, RL = 2.7\Omega$ $I_D = 1A, V_{GEN} = 10V$ $R_G = 3\Omega$		7	11	ns
Turn-On Rise Time	t_r			15	20	
Turn-Off Delay Time	$t_{d(off)}$			38	50	
Turn-Off Fall Time	t_f			3	10	
Input Capacitance	C_{iss}	$V_{DS} = 10V, V_{GS} = 0V$ $f = 1.0 \text{ MHz}$		340		pF
Output Capacitance	C_{oss}			115		
Reverse Transfer Capacitance	C_{rss}			33		
Source-Drain Diode						
Max. Diode Forward Current	I_s				1.6	A
Diode Forward Voltage	V_{SD}	$I_s = 1.6A, V_{GS} = 0V$			1.2	V

Note: Pulse test: pulse width <= 300us, duty cycle<= 2%



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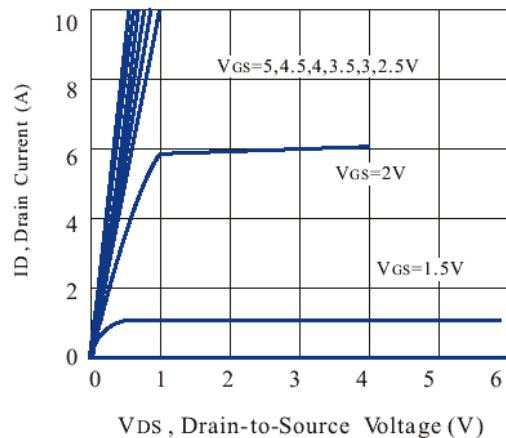


Figure 1. Output Characteristics

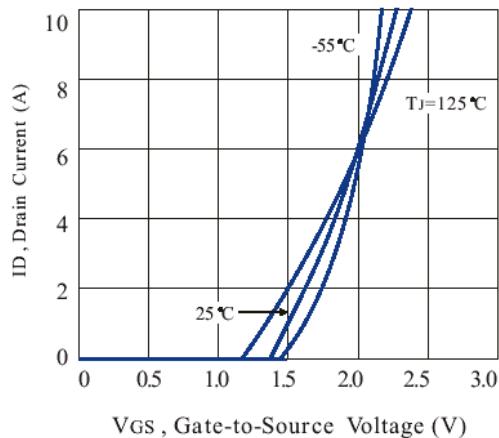


Figure 2. Transfer Characteristics

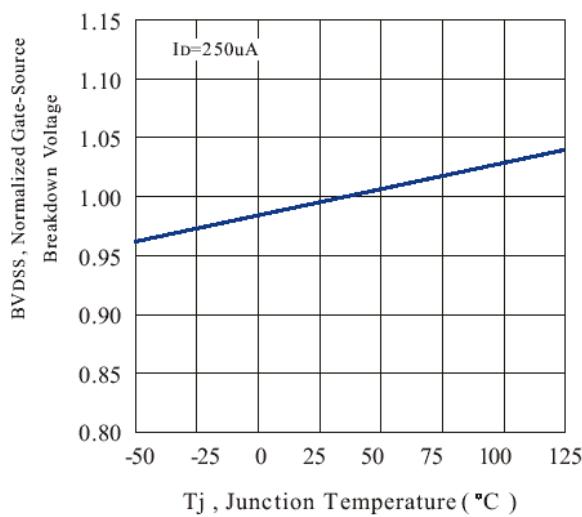


Figure 3. Breakdown Voltage Variation with Temperature

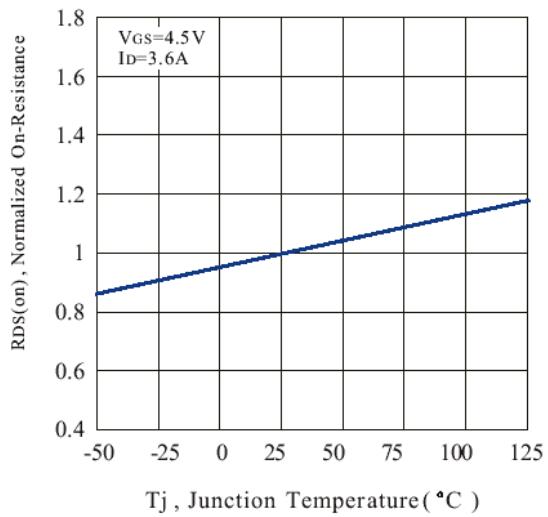


Figure 4. On-Resistance Variation with Temperature

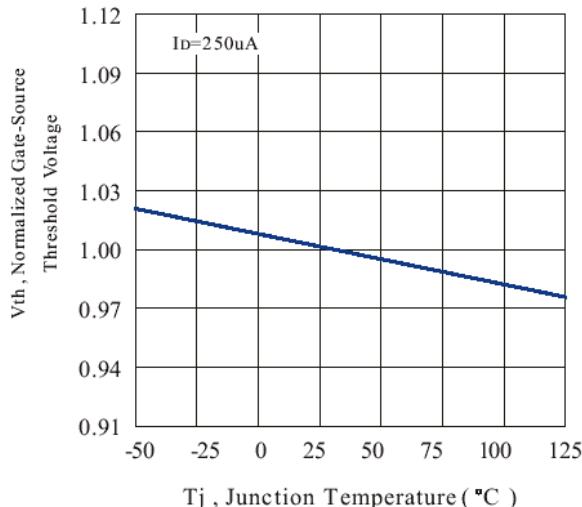


Figure 5. Gate Threshold Variation with Temperature

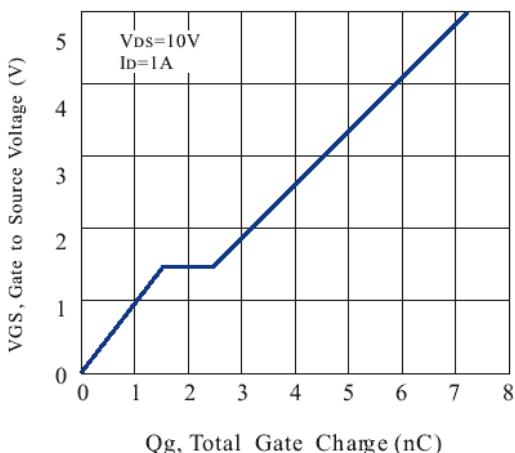


Figure 6. Gate Charge